

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







OPERATING CHARACTERISTICS AT 25°C AMBIENT									
LED CHARACTERISITICS	MIN	TYP	MAX	UNITS	TEST CONDITION				
LUMINOUS INTENSITY	2500	4200	7200	mc d	Ir = 20 mA				
PEAK WAVELENGTH		518		nm					
DOMINANT WAVELENGTH	520	527	535	nm					
VIEWING ANGLE (2 ⊖1/2)		30		DEG					
FORWARD VOLTAGE		3.8	4.3	٧	Ir = 20 mA				

REV	ECN NO	REVISIONS	DRN	CKD	APP	DATE
Α		NEW RELEASE	TC	Ν.Ο.	MES	10-5-06
В		UPDATED LED SPECS. REMOVED NOTES 2 & 4.	KLJ	JLC	Ν.Ο.	4-15-09

ABSOLUTE MAXIMUM RATINGS 25°C AMBIENT		
PARAMETER	VALUE	UNITS
DC FORWARD CURRENT	30	mΑ
PEAK FORWARD CURRENT (1/10 DUTY CYCLE, O.Ims PULSE WIDTH)	100	mΑ
POWER DISSIPATION	135	mW
DERATING LINEARLY FROM 30°C	0.5	mA/°C
REVERSE VOLTAGE (IR = 100µA)	5	٧
OPERATING TEMPERATURE RANGE	-40 to +85	°C
STORAGE TEMPERATURE RANGE	-40 to +100	°C
DIP-DRAG SOLDER TEMPERATURE (FOR 5 SEC.)	260	°C

NOTES:

- I. LENS COLOR: WATER CLEAR
- 2. LEAD SPACING MEASURED NEAR EPOXY PACKAGE.
- 3. THIS ASSEMBLY CONTAINS ELECTROSTATIC DISCHARGE SENSITIVE DEVICES (ESDS). MAINTAIN ALL PRECAUTIONARY MEASURES DURING ASSEMBLY, HANDLING, AND STORAGE IN ACCORDANCE WITH IPC-A-610.
- 4. DIALIGHT PART NUMBER: 521-9947F
- 5. PART NUMBER WITH "F" SUFFIX ENDING IS ROHS COMPLIANT. THE BAG PACKAGING IS MARKED WITH "ROHS COMPLIANT" LABEL OR EQUIVALENT MARKINGS. PART CAN BE WAVE SOLDERED, DIP SOLDERED, OR HAND SOLDERED USING TYPICAL LEAD-FREE SOLDERING PROCESS WITH MAX. 260°C TEMPERATURE FOR 5 SEC.





